imall

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MMDL6050T1G, SMMDL6050T1G

Switching Diode

Features

- AEC-Q101 Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Continuous Reverse Voltage	V _R	70	Vdc
Peak Forward Current	١ _F	200	mAdc
Peak Forward Surge Current	I _{FM(surge)}	500	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 1) @T _A = 25°C Derate above 25°C	P _D	200 1.57	mW mW/°C
Thermal Resistance, Junction-to-Ambient	RθJA	635	°C/W
Junction and Storage Temperature	T _J , T _{stg}	-55 to 150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-4 Minimum Pad.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					
Reverse Breakdown Voltage (I _(BR) = 100 μAdc)	V _(BR)	70	-	Vdc	
Reverse Voltage Leakage Current (V _R = 50 Vdc)	۱ _R	-	0.1	μAdc	
Forward Voltage (I _F = 1.0 mAdc) (I _F = 100 mAdc)	V _F	0.55 0.85	0.7 1.1	Vdc	
Reverse Recovery Time (I _F = I _R = 10 mAdc, I _{R(REC)} = 1.0 mAdc) (Figure 1)	t _{rr}	-	4.0	ns	
Capacitance (V _R = 0 V)	С	-	2.5	pF	



ON Semiconductor®

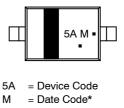
http://onsemi.com



PLASTIC SOD-323 **CASE 477** STYLE 1



MARKING DIAGRAM



= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

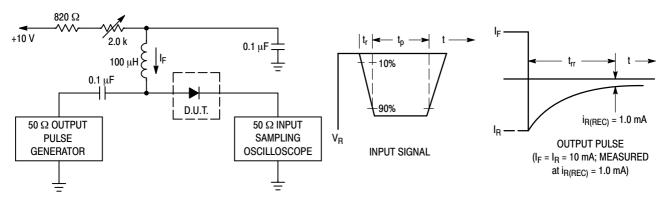
ORDERING INFORMATION

Device	Package	Shipping [†]
MMDL6050T1G	SOD-323 (Pb-Free)	3,000 / Tape & Reel
SMMDL6050T1G	SOD-323 (Pb-Free)	3,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MMDL6050T1G, SMMDL6050T1G



Notes: 1. A 2.0 k Ω variable resistor adjusted for a Forward Current (I_F) of 10 mA. 2. Input pulse is adjusted so I_{R(peak)} is equal to 10 mA.

3. t_p » t_{rr}

Figure 1. Recovery Time Equivalent Test Circuit

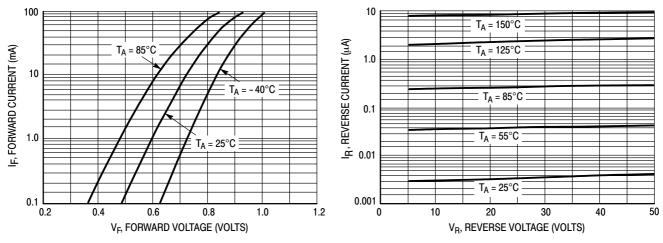
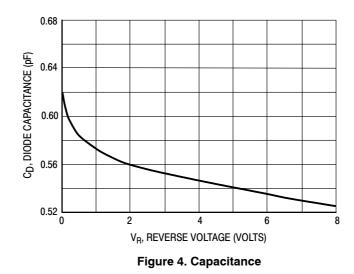


Figure 2. Forward Voltage

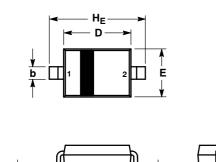
Figure 3. Leakage Current



MMDL6050T1G, SMMDL6050T1G

PACKAGE DIMENSIONS

SOD-323 CASE 477-02 **ISSUE H**







NOTES

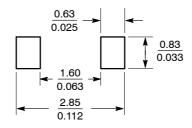
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
 - CONTROLLING DIMENSION: MILLIMETERS.
- LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING. З.
- 4. DIMENSIONS A AND B DO NOT INCLUDE MOLD
- FLASH, PROTRUSIONS OR GATE BURRS. DIMENSION I IS MEASURED FROM END OF RADIUS 5

DIMENSION E IS MEASURED THOM END OF HADI							
		MILLIMETERS			INCHES		
D	IM	MIN	NOM	MAX	MIN	NOM	MAX
A	4	0.80	0.90	1.00	0.031	0.035	0.040
Α	1	0.00	0.05	0.10	0.000	0.002	0.004
Α	3	0.15 REF			0.006 REF		
k	C	0.25	0.32	0.4	0.010	0.012	0.016
0	2	0.089	0.12	0.177	0.003	0.005	0.007
E	2	1.60	1.70	1.80	0.062	0.066	0.070
E	Ξ	1.15	1.25	1.35	0.045	0.049	0.053
L	_	0.08			0.003		
H	F	2.30	2.50	2.70	0.090	0.098	0.105

STYLE 1: PIN 1. CATHODE (POLARITY BAND)

2. ANODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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